

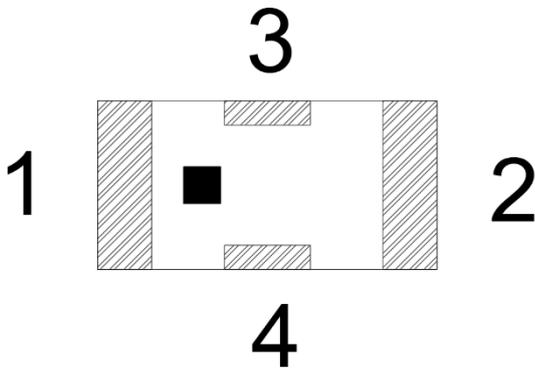
Features

- Multilayer monolithic construction yields high reliability
- Low insertion loss and small size SMD chip design
- Can simplify your complex tuning and circuit design
- LTCC process

Specifications

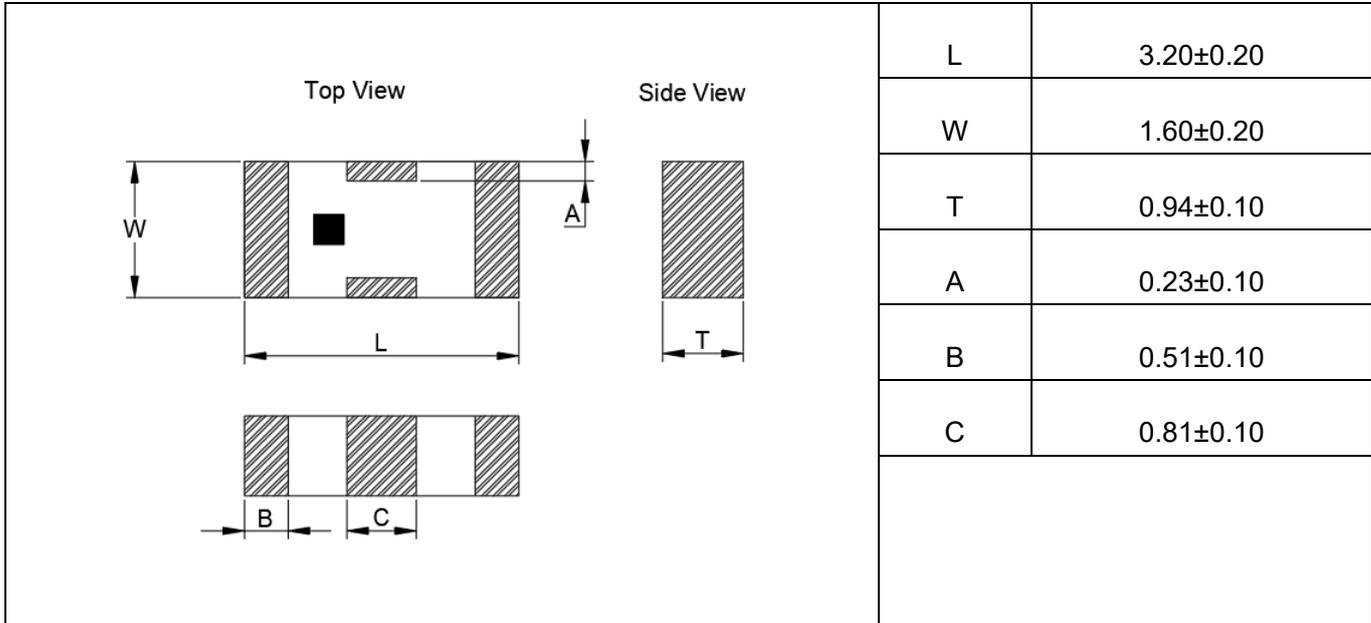
NO.	Parameter	Frequency (MHz)	SPEC		
			Min.	TYP	Max.
1	Insertion Loss (dB)	DC~500		1.1	1.6
		750		3.0	
2	VSWR	DC~500		1.15	1.5
3	Attenuation (dB)	900	20	33	
		1100~TBD		40	
4	In/Output Impedance (Ω)		50		

Construction



PIN	Connection
1	Input Port
2	Output Port
3	GND
4	GND

Dimensions



Typical Electrical Characteristics (T=25°C)

